

Low-Power, SC70/SOT µP Reset Circuit with Capacitor-Adjustable Reset Timeout Delay

GENERAL DESCRIPTION

The SGM802 low-power micro-processor supervisor circuit monitors system voltages from 1.6V to 5V. This device performs a single function: it asserts a reset signal whenever the $V_{\rm CC}$ supply voltage falls below its reset threshold. The reset output remains asserted for the reset timeout period after $V_{\rm CC}$ rises above the reset threshold. The reset timeout is externally set by a capacitor to provide more flexibility.

The SGM802 has an active-high, push-pull reset output. It is available in Green SC70-4 (R) and SOT-143 packages. The SGM802 is specified over an ambient temperature range of -40°C to +85°C.

FEATURES

- Monitor System Voltages from 1.6V to 5V
- Capacitor-Adjustable Reset Timeout Period
- Low Quiescent Current: 3µA (TYP)
- Push-Pull RESET Output Option
- Guaranteed RESET Valid to V_{cc} = 1V
- Immune to Short V_{CC} Transients
- Available in Green SC70-4 (R) and SOT-143
 Packages

APPLICATIONS

Portable Equipment

Battery-Powered Computers/Controllers

Automotive

Medical Equipment

Intelligent Instruments

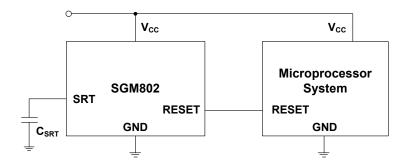
Embedded Controllers

Critical µP Monitoring

Set-Top Boxes

Computers

TYPICAL APPLICATION





PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	RESET THRESHOLD (V)	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION	
		1.63	1.63 SGM802-1.63YKA4G/TR		Tape and Reel, 3000	
	SOT-143	2.32	SGM802-2.32YKA4G/TR	S79XX	Tape and Reel, 3000	
	501-143	2.63	SGM802-2.63YKA4G/TR	S7AXX	Tape and Reel, 3000	
SGM802		2.93	SGM802-2.93YKA4G/TR	S7BXX	Tape and Reel, 3000	
3GIVI602		1.63	SGM802-1.63YC4G/TR	S7DXX	Tape and Reel, 3000	
	CC70 4 (D)	2.32	SGM802-2.32YC4G/TR	S7EXX	Tape and Reel, 3000	
	SC70-4 (R)	2.63	SGM802-2.63YC4G/TR	S7FXX	Tape and Reel, 3000	
		2.93	SGM802-2.93YC4G/TR	S80XX	Tape and Reel, 3000	

MARKING INFORMATION

NOTE: XX = Date Code.

YYY X X

Date Code - Month
Date Code - Year
Serial Number

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

All Voltages Referenced to GND	
V _{CC}	0.3V to 6V
SRT, RESET (Push-Pull)	$0.3V$ to $(V_{CC} + 0.3V)$
Input Current (All Pins)	20mA
Output Current (RESET)	20mA
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM	3000V
MM	300V

RECOMMENDED OPERATING CONDITIONS

Operating Temperature Range-40°C to +85°C

OVERSTRESS CAUTION

Stresses beyond those listed may cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational section of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

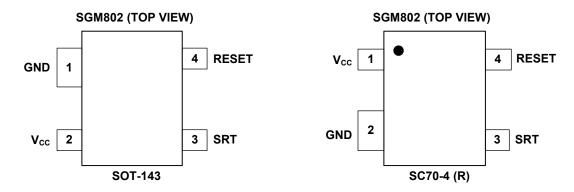
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time.

PIN CONFIGURATIONS



PIN DESCRIPTION

PIN		NAME	FUNCTION		
SOT-143	SC70-4 (R)	INAIVIE	FUNCTION		
1	2	GND	Ground.		
2	1	V _{CC}	Supply Voltage and Reset Threshold Monitor Input.		
3	3	SRT	Set Reset Timeout Input. Connect a capacitor between SRT and ground to set the timeout period. Determine the period as follows: $t_{RP} = 2.6 \times 10^6 \times C_{SRT} + 340 \times 10^{-6}$ with t_{RP} in seconds and C_{SRT} in farads.		
4	4	RESET	RESET changes from low to high whenever V_{CC} drops below the selected reset threshold voltage. RESET remains high for the reset timeout period after V_{CC} exceeds the reset threshold.		

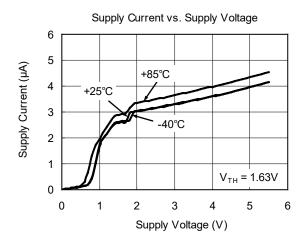
ELECTRICAL CHARACTERISTICS

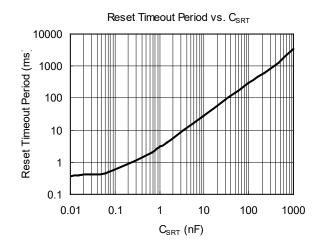
 $(V_{CC} = 1V \text{ to } 5.5V, T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ typical values are at } V_{CC} = 5V \text{ and } T_A = +25^{\circ}\text{C}, \text{ unless otherwise specified.})$

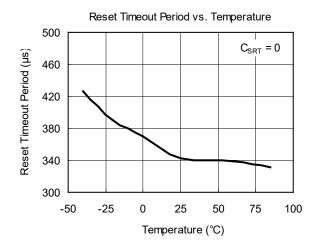
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Supply Voltage Range	V _{CC}		1.0		5.5	V	
		V _{CC} ≤ 5.0V		3.9	7.0		
Supply Current	I _{cc}	V _{CC} ≤ 3.3V		3.4	5.5	μA	
		V _{CC} ≤ 2.0V 3.0	4.8				
V _{CC} Reset Threshold Accuracy	\/	T _A = +25°C	V _{TH} - 2.5%		V _{TH} + 2.5%	V	
V _{CC} Reset Threshold Accuracy	V_{TH}	T _A = -40°C to +85°C	V _{TH} - 3.5%		V _{TH} + 3.5%	V	
Hysteresis	V _{HYST}			$4 \times V_{TH}$		mV	
V _{CC} to Reset Delay	t _{RD}	V _{CC} falling at 1mV/μs		80		μs	
Reset Timeout Period		C _{SRT} = 1500pF	3.00	4.25 5.75		ma	
Reset Timeout Period	t _{RP}	C _{SRT} = 0		0.34		ms	
V _{SRT} Ramp Current	I _{RAMP}	$V_{SRT} = 0$ to 0.65V, $V_{CC} = 1.6$ V to 5V		210		nA	
V _{SRT} Ramp Threshold	$V_{\text{TH-RAMP}}$	V _{CC} = 1.6V to 5V (V _{RAMP} rising)		0.6		V	
		V _{CC} ≥ 1.0V, I _{SOURCE} = 1µA	0.8 × V _{CC}				
DESET Output Voltage High	\/	V _{CC} ≥ 1.8V, I _{SOURCE} = 150μA 0.8 × V _{CC}			V		
RESET Output Voltage High	V _{OH}	V _{CC} ≥ 2.7V, I _{SOURCE} = 500μA	0.8 × V _{CC}			V	
		V _{CC} ≥ 4.5V, I _{SOURCE} = 800μA	0.8 × V _{CC}]	
		V _{CC} ≥ 1.8V, I _{SINK} = 500µA			0.3		
RESET Output Voltage Low	V_{OL}	V_{OL} $V_{CC} \ge 2.7V$, $I_{SINK} = 1.2mA$		0.3	V		
		V _{CC} ≥ 4.5V, I _{SINK} = 3.2mA			0.4		

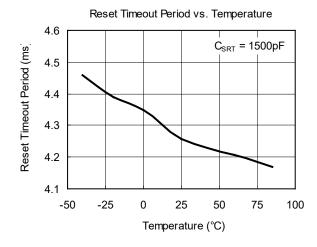
TYPICAL PERFORMANCE CHARACTERISTICS

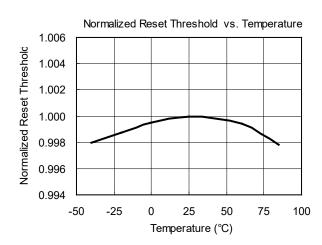
 V_{CC} = 5V, C_{SRT} = 1500pF, T_A = +25°C, unless otherwise noted.

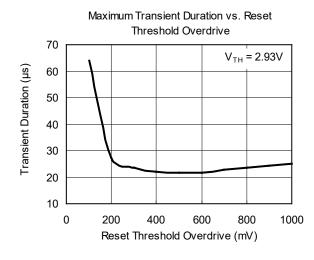






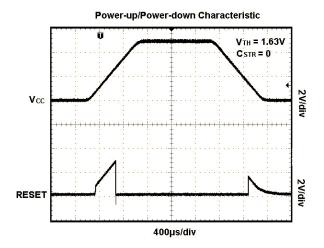






TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 V_{CC} = 5V, C_{SRT} = 1500pF, T_A = +25°C, unless otherwise noted.





DETAILED DESCRIPTION

Reset Output

The reset output is typically connected to the reset input of a $\mu P.$ A $\mu P's$ reset input starts or restarts the μP in a known state. The SGM802 μP supervisory circuit provides the reset logic to prevent code-execution errors during power-up, power-down, and brownout conditions.

RESET changes from low to high whenever V_{CC} drops below the threshold voltage. Once V_{CC} exceeds the threshold voltage, RESET remains high for the capacitor- adjustable reset timeout period.

This device output is guaranteed valid for $V_{CC} > 1V$.

Operating as a Voltage Detector

The SGM802 can be operated in a voltage detector mode by floating the SRT pin. The reset delay times for V_{CC} rising above or falling below the threshold are not significantly different. The reset output is deasserted smoothly without false pulses.

Selecting a Reset Capacitor

The reset timeout period is adjustable to accommodate a variety of μP applications. Adjust the reset timeout period (t_{RP}) by connecting a capacitor (C_{SRT}) between SRT and ground. Calculate the reset timeout capacitor as follows:

$$C_{SRT} = (t_{RP} - 340 \times 10^{-6})/(2.6 \times 10^{6})$$

where t_{RP} is in seconds and C_{SRT} is in farads.

The reset delay time is set by a current/capacitor-controlled ramp compared to an internal 0.6V reference. An internal 210nA ramp current source charges the external capacitor. The charge to the capacitor is cleared when a reset condition is detected. Once the reset condition is removed, the voltage on the capacitor ramps according to the formula: dV/dt = I/C. The C_{SRT} capacitor must ramp to 0.6V to deassert the reset. C_{SRT} must be a low-leakage (<10nA) type capacitor; ceramic is recommended.

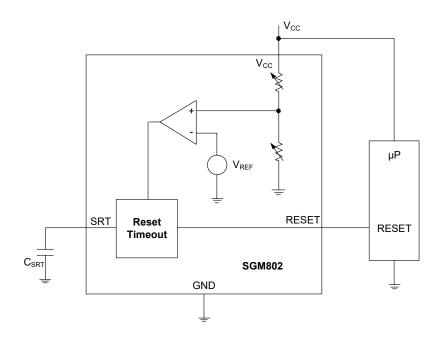


Figure 1. Typical Operating Circuit

APPLICATION INFORMATION

Negative-Going Vcc Transients

In addition to issuing a reset to the μP during power-up, power-down, and brownout conditions, this supervisor is relatively immune to short-duration negative-going transients (glitches). The graph Maximum Transient Duration vs. Reset Threshold Overdrive in the Typical Performance Characteristics shows this relationship.

The area below the curve of the graph is the region in which these devices typically do not generate a reset pulse. This graph was generated using a negative-going pulse applied to $V_{\rm CC}$, starting above the actual reset threshold ($V_{\rm TH}$) and ending below it by the magnitude indicated (reset-threshold overdrive). As the magnitude of the transient decreases (further below the reset threshold), the maximum allowable pulse width-decreases. Typically, a $V_{\rm CC}$ transient that goes 100mV below the reset threshold and lasts 50µs or less does not cause a reset pulse to be issued.

Ensuring a Valid RESET Down to V_{CC} = 0

When V_{CC} falls below 1V, RESET current-sinking (sourcing) capabilities decline drastically.

For applications using the SGM802, a $100k\Omega$ pull-up resistor between RESET and V_{CC} holds RESET high when V_{CC} falls below 1V (Figure 2).

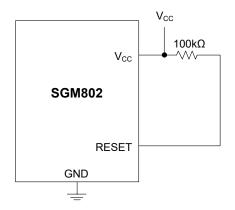


Figure 2. Ensuring RESET Valid to $V_{CC} = 0$

Layout Consideration

SRT is a precise current source. When developing the layout for the application, be careful to minimize board capacitance and leakage currents around this pin. Traces connected to SRT should be kept as short as possible. Traces carrying high-speed digital signals and traces with large voltage potentials should be routed as far from SRT as possible. Leakage current and stray capacitance (e.g., a scope probe) at this pin could cause errors in the reset timeout period. When evaluating these parts, use clean prototype boards to ensure accurate reset periods.

REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

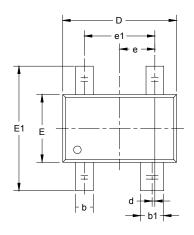
DECEMBER 2014 - REV.A.1 to REV.A.2

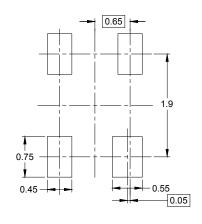
Added Green (RoHS & HSF) Information	2
JANUARY 2013 – REV.A to REV.A.1	

Changes from Original (MARCH 2012) to REV.A

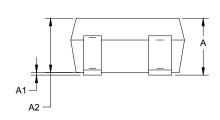


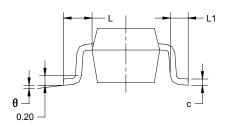
PACKAGE OUTLINE DIMENSIONS SC70-4 (R)





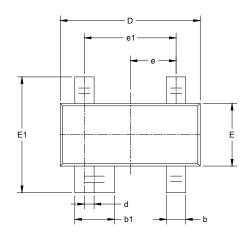
RECOMMENDED LAND PATTERN (Unit: mm)

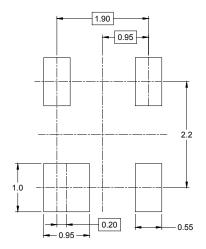




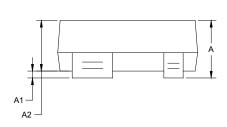
Symbol	_	nsions meters		ensions nches	
	MIN	MAX	MIN	MAX	
Α	0.900	1.100	0.035	0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.000	0.035	0.039	
b	0.250	0.400	0.010	0.016	
b1	0.350	0.500	0.014	0.020	
С	0.080	0.150	0.003	0.006	
d	0.050	OTYP	0.002TYP		
D	2.000	2.200	0.079	0.087	
Е	1.150	1.350	0.045	0.053	
E1	2.150	2.450	0.085	0.096	
е	0.65	TYP	0.026 TYP		
e1	1.200	1.400	0.047	0.055	
L	0.525	REF	0.021	REF	
L1	0.260	0.460	0.010	0.018	
θ	0°	8°	0°	8°	

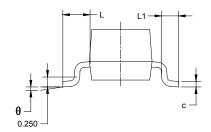
PACKAGE OUTLINE DIMENSIONS SOT-143





RECOMMENDED LAND PATTERN (Unit: mm)

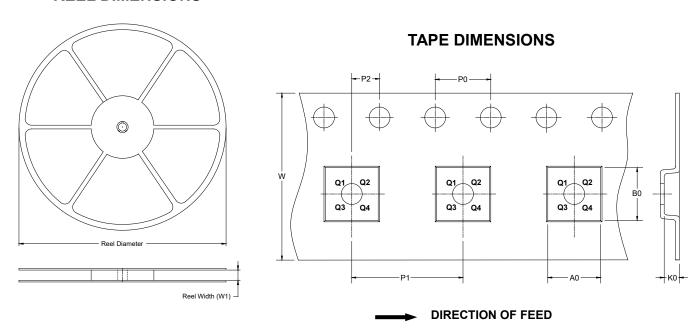




Symbol	-	nsions meters		nsions ches	
	MIN	MAX	MIN	MAX	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
b1	0.750	0.900	0.030	0.035	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
d	0.200) TYP	0.008 TYP		
Е	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.95	TYP	0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.55	REF	0.022	REF	
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

TAPE AND REEL INFORMATION

REEL DIMENSIONS

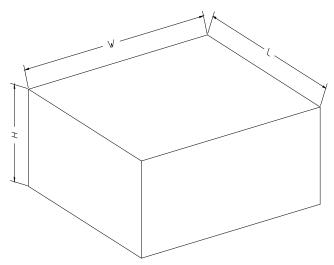


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SC70-4 (R)	7"	9.5	3.20	2.80	1.30	4.0	4.0	2.0	8.0	Q3
SOT-143	7"	9.5	3.20	2.80	1.30	4.0	4.0	2.0	8.0	Q3

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18